



圖示 Hình minh họa

The diagram illustrates the transfer direction of components from the old motherboard (top) to the new motherboard (bottom). The components and their transfer directions are as follows:

- H.1**: Old motherboard (top).
- H.2**: Heatsink. Tấm tản nhiệt 400.01103.035.
- H.3**: New motherboard (bottom).
- H.4**: Thermal pad 480.02186.005*1 and Thermal pad 480.02185.005*4.
- H.5**: TAPE - băng dính 475.00512.005.
- H.6**: New motherboard (bottom) with components 376.00050.005, 376.00052.005, 376.00051.005, and 376.00039.005.
- H.7**: New motherboard (bottom) with components 1. 376.00052.005 and 2. 376.00051.005.

Transfer direction
Hướng chuyển bản

※ 使用材料(零件明細表) Bảng chi tiết các vật liệu sử dụng

[illegible]